

# High Power RF GaN Amplifier

## 450 W, 50 V, 4900 - 5000 MHz



**MACOM PURE CARBIDE**

**MAPC-C50450-DP**

Rev. V1

### Features

- GaN on SiC HEMT Technology
- Designed for Asymmetrical Doherty Application
- 47.4 dBm Average Output Power
- 450 W Peak Output Power
- Input and Output Pre-matched Device
- Low Thermal Resistance
- 100% DC and RF Tested
- RoHS\* Compliant

### Applications

- Point-to-Point
- Infrastructure

### Description

The MAPC-C50450-DP is a GaN on Silicon Carbide HEMT Amplifier designed for asymmetrical Doherty applications. The device is optimized for the frequency band of 4900 to 5000 MHz. This product is housed in an over-molded TO-package.

### Typical Doherty Performance:

$V_{DS} = 50\text{ V}$ ,  $I_{DQm} = 250\text{ mA}$ ,  $V_{GSpk} = 250\text{ mA} - 2.5\text{ V}$ ,  
 $P_{OUT} = 47.4\text{ dBm}$ ,  $T_A = 25^\circ\text{C}$

Note: Performance in MACOM Doherty Application Fixture. Single Carrier W-CDMA Channel Bandwidth 3.84 MHz, PAR 10 dB @ 0.01% CCDF.

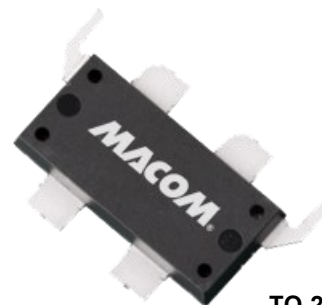
Frequency (MHz)	Gain (dB)	Efficiency (%)	Output PAR (dB)	ACPR (dBc)
4900	13.3	38.9	7.7	-28.4
4950	13.1	38.4	8.0	-28.7
5000	13.0	38.6	7.9	-28.1

### Ordering Information

Part Number	Package
MAPC-C50450-DPTR1	250 pc Tape and Reel <sup>1</sup>
MAPC-C50450-DPTR2	50 pc Tape and Reel <sup>1</sup>
MAPC-C50450-DPSB1	Sample Board

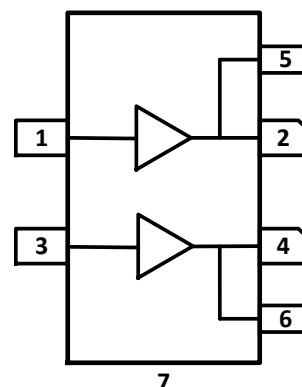
1. See application note AN-0004525 for Tape & Reel information.

\* Restrictions on Hazardous Substances, compliant to current RoHS EU directive.



TO-248-4/2

### Functional Schematic



### Pin Configuration

Pin #	Pin Name	Function
1	RF <sub>IN</sub> / V <sub>G1</sub>	RF Input / Gate (Main)
2	RF <sub>OUT</sub> / V <sub>D1</sub>	RF Output / Drain (Main)
3	RF <sub>IN</sub> / V <sub>G2</sub>	RF Input / Gate (Peak)
4	RF <sub>OUT</sub> / V <sub>D2</sub>	RF Output / Drain (Peak)
5, 6	VBW Lead	Drain Video Decoupling. No DC Bias
7	Flange <sup>2</sup>	Ground / Source

2. The flange on the package bottom must be connected to RF, DC and thermal ground.

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### RF Electrical Characterization:

$T_A = 25^\circ\text{C}$ ,  $V_{DS} = 50\text{ V}$ ,  $I_{DQm} = 250\text{ mA}$ ,  $V_{GSpk} = 250\text{ mA} - 2.5\text{ V}$

Note: Performance in MACOM Doherty Application Fixture. Single Carrier-W-CDMA Channel Bandwidth 3.84 MHz, PAR 10 dB @ 0.01% CCDF.

Parameter	Test Conditions	Symbol	Min.	Typ.	Max.	Units
Power Gain	5000 MHz, Pout = 47.4 dBm	Gp	—	13.0	—	dB
Drain Efficiency	5000 MHz, Pout = 47.4 dBm	$\eta$	—	38.6	—	%
Output CCDF @ 0.01%	5000 MHz, Pout = 47.4 dBm	PAR	—	7.9	—	dB
Adjacent Channel Power	5000 MHz, Pout = 47.4 dBm	ACP	—	-28.2	—	dBc
Input Return Loss	5000 MHz, Pout = 47.4 dBm	IRL	—	-13.0	—	dB
Gain Flatness	5000 MHz, Pout = 47.4 dBm	$G_F$	—	0.3	—	dB
Gain Variation (-40°C to +105°C)	5000 MHz, Pout = 47.4 dBm	$\Delta G$	—	-0.0185	—	dB/°C
Power Variation (-40°C to +105°C)	5000 MHz, Pulsed 10% DC	$\Delta P_{3dB}$	—	-0.004	—	dB/°C
Ruggedness: Output Mismatch	All phase angles	$\Psi$	VSWR =10:1, No device damage			

### RF Electrical Test Specifications:

$T_A = 25^\circ\text{C}$ ,  $V_{DS} = 48\text{ V}$ ,  $I_{DQm} = 250\text{ mA}$ ,  $V_{GSpk} = 250\text{ mA} - 2.5\text{ V}$

Note: Performance in MACOM Doherty Production Test Fixture. Single Carrier- W-CDMA Channel Bandwidth 3.84MHz, PAR 10dB @ 0.01% CCDF.

Parameter	Test Conditions	Symbol	Min.	Typ.	Max.	Units
Power Gain	4900 MHz, Pout = 47.4 dBm	Gp	7.5	9.7	—	dB
	5000 MHz, Pout = 47.4 dBm		8.5	10.5	—	
Drain Efficiency	4900 MHz, Pout = 47.4 dBm	$\eta$	27.0	30.9	—	%
	5000 MHz, Pout = 47.4 dBm		28.0	31.9	—	
Output CCDF @ 0.01%	4900 MHz, Pout = 47.4 dBm	PAR	5.7	6.6	—	dB
	5000 MHz, Pout = 47.4 dBm		5.5	6.3	—	
Adjacent Channel Power	4900 MHz, Pout = 47.4 dBm	ACP	—	-30.9	-25.5	dBc
	5000 MHz, Pout = 47.4 dBm		—	-26.2	-22.0	

## DC Electrical Characteristics $T_A = 25^\circ\text{C}$

Parameter	Test Conditions	Symbol	Min.	Typ.	Max.	Units
<b>Main Amplifier</b>						
Drain-Source Leakage Current	$V_{GS} = -8\text{ V}, V_{DS} = 10\text{ V}$	$I_{DLK}$	—	—	3.5	mA
Drain-Source Leakage Current	$V_{GS} = -8\text{ V}, V_{DS} = 130\text{ V}$	$I_{DLK}$	—	—	7.0	mA
Gate-Source Leakage Current	$V_{GS} = -8\text{ V}, V_{DS} = 50\text{ V}$	$I_{GLK}$	-5.7	—	—	mA
Gate-Source Leakage Current	$V_{GS} = -8\text{ V}, V_{DS} = 130\text{ V}$	$I_{GLK}$	-3.0	—	—	mA
Gate Threshold Voltage	$V_{DS} = 10\text{ V}, I_D = 25\text{ mA}$	$V_T$	-3.5	-2.3	-1.7	V
<b>Peak Amplifier</b>						
Drain-Source Leakage Current	$V_{GS} = -8\text{ V}, V_{DS} = 10\text{ V}$	$I_{DLK}$	—	—	3.5	mA
Drain-Source Leakage Current	$V_{GS} = -8\text{ V}, V_{DS} = 130\text{ V}$	$I_{DLK}$	—	—	7.0	mA
Gate-Source Leakage Current	$V_{GS} = -8\text{ V}, V_{DS} = 50\text{ V}$	$I_{GLK}$	-5.7	—	—	mA
Gate-Source Leakage Current	$V_{GS} = -8\text{ V}, V_{DS} = 130\text{ V}$	$I_{GLK}$	-3.0	—	—	mA
Gate Threshold Voltage	$V_{DS} = 10\text{ V}, I_D = 50\text{ mA}$	$V_T$	-3.5	-2.2	-1.7	V

## Recommended Operating Voltages

Parameter	Test Conditions	Units	Min.	Typ.	Max.
Drain Operating Voltage	—	V	—	50	—
Gate Quiescent Voltage	$V_{DS} = 50\text{ V}, I_D = 250\text{ mA}$	V	-3.5	-2.2	-1.9

## Moisture Sensitivity Level

Level	Test Standard	Package Temperature	Unit
3	IPC/JEDEC J-STD-020	260	$^\circ\text{C}$

## Absolute Maximum Ratings<sup>3,4,5,6</sup>

Parameter	Absolute Maximum
Drain Source Voltage, $V_{DS}$	130 V
Operating Voltage, $V_{DS}$	55 V
Gate Source Voltage, $V_{GS}$	-10 to 2 V
Gate Current (Main), $I_G$	25 mA
Gate Current (Peak), $I_G$	50 mA
Storage Temperature Range	-65°C to +150°C
Case Operating Temperature Range	-40°C to +125°C
Channel Operating Temperature Range, $T_{CH}$	-40°C to +225°C
Absolute Maximum Channel Temperature	+225°C

3. Exceeding any one or combination of these limits may cause permanent damage to this device.

4. MACOM does not recommend sustained operation above maximum operating conditions.

5. Operating at drain source voltage  $V_{DS} < 55$  V will ensure MTTF >  $2.51 \times 10^6$  hours.

6. Operating at nominal conditions with  $T_{CH} \leq 225^\circ\text{C}$  will ensure MTTF >  $2.51 \times 10^6$  hours.

## Thermal Characteristics<sup>7</sup>

Parameter	Test Conditions	Symbol	Typical	Units
Thermal Resistance using Finite Element Analysis, $T_J$	$P_{DISS} = 84$ W $T_C = 116^\circ\text{C}, T_{CH} = 225^\circ\text{C}$	$R_{\theta}(\text{FEA})$	1.3	°C/W
Thermal Resistance using Infrared Measurement of Die Surface Temperature	$P_{DISS} = 84$ W $T_C = 116^\circ\text{C}, T_{CH} = 225^\circ\text{C}$	$R_{\theta}(\text{IR})$	1.1	°C/W

7. Case temperature measured using thermocouple embedded in heat-sink. Contact local applications support team for more details on this measurement.

## Bias Sequencing

### Bias ON

1. Ensure RF is turned off
2. Apply pinch-off voltage of -5 V to the gate
3. Apply nominal drain voltage
4. Bias gate to desired quiescent drain current
5. Apply RF

### Bias OFF

1. Turn RF off
2. Apply pinch-off voltage to the gate
3. Turn-off drain voltage
4. Turn-off gate voltage

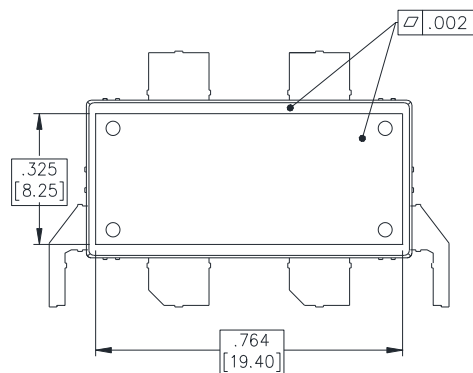
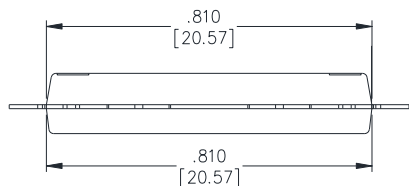
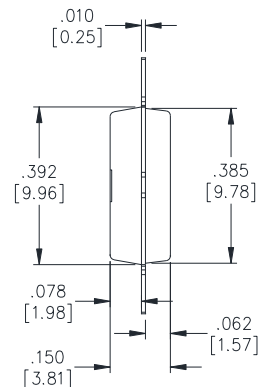
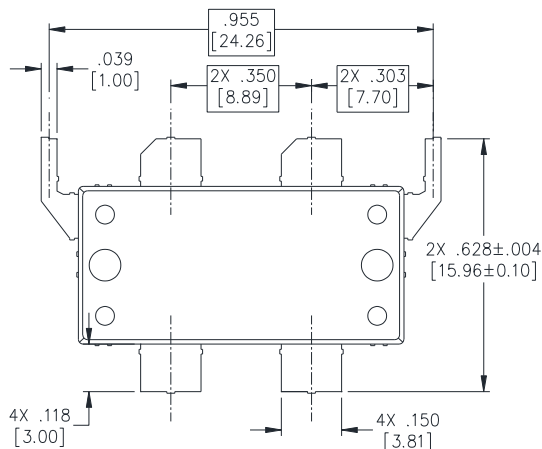
## Handling Procedures

Please observe the following precautions to avoid damage:

## Static Sensitivity

Gallium Nitride Circuits are sensitive to electrostatic discharge (ESD) and can be damaged by static electricity. Proper ESD control techniques should be used when handling these devices.

## TO-248-4/2 Package Dimensions



### NOTES:

1. ALL DIMENSIONS SHOWN AS in[mm]. CONTROLLING DIMENSIONS ARE IN IN AND CONVERTED mm DIMENSIONS ARE NOT NECESSARILY EXACT.
2. ALL TOLERANCES ARE ±.002 [0.05] UNLESS OTHERWISE NOTED.
3. ALL METAL SURFACES ARE MATTE Sn PLATED EXCEPT FOR CUT EDGES.
4. PACKAGE BODY AND LEAD DIMENSIONS DO NOT INCLUDE MOLD AND METAL PROTRUSIONS. ALLOWABLE PROTRUSION IS .012 [0.30] IN GENERAL AND .004 [0.10] FOR PROTRUSIONS CONNECTED TO SOURCE

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